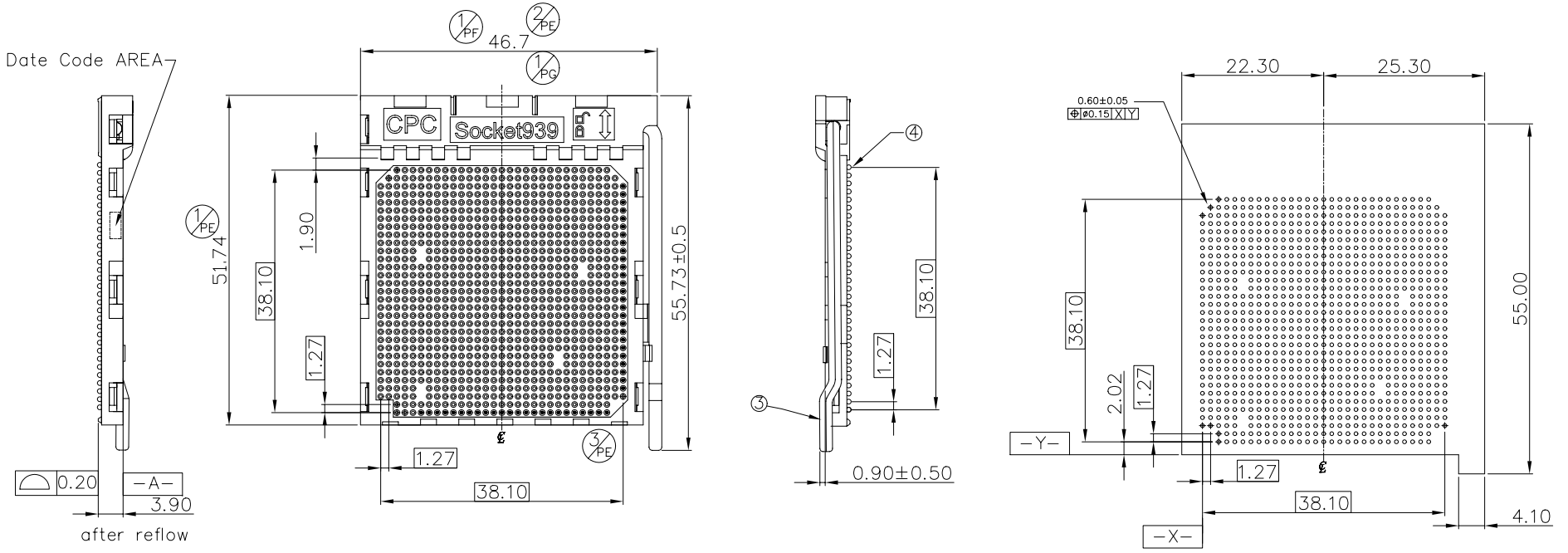
RoHS Compliant
2002/95/EC



1. 127083FK939□□00PY
   F
   F.Selective plating
   J1−05μ"Min.Gold in contact area.
   J2−Gold flash in contact area.
   J3−10μ"Min.Gold in contact area.
   J4−15μ"Min.Gold in contact area.
   J5−30μ"Min.Gold in contact area.

NO.	DESCRIPTION	MATERIAL	COLOR	REMARK
5	TERMINAL	Copper Alloy	———	GOLD PLATED OVER Ni
4	Solder Ball	Solder Alloy Composition	———	———
3	HANDLE	Stainless Steel	———	———
2	COVER	High Temp.Plastic	Natural	UL 94V−0
1	BASE	High Temp.Plastic	BLACK	UL 94V−0

ECN(DCN) NO.	REV	DATE	DESCRIPTION	CHANGE	APPRO.		
———	PG	05/10/06'	結構變更			Angle	±2°
———	PF	04/26/06'	結構變更	吳玉明	范政徽	X.	±0.50
———	PE	04/18/06'	結構變更	吳玉明	范政徽	X.X	±0.25
———	PD	11/18/05'	修改標注尺寸	吳玉明	范政徽	X.XX	±0.15

GENERAL TOLERANCE UNLESS OTHERWISE NOTED

DRAW	陳葳葳	04/18/05'
DESIGN	吳玉明	04/18/05'
CHECK	范政徽	04/18/05'
APPRO.	范政徽	04/18/05'

SUYIN
CONNECTOR SOCKET DEP

CUSTOMER COPY	TITLE:	Socket 939 Solder Ball Type
	PART NO.	127083FK939JX00PY
	PART NO. (OLD)	———
	FILE NAME.	C ING 127083FK939JX00PY−C
	SCALE 1:1	UNIT:mm A4 SHEET: 1 of 1

SOCKET DEP

050604−EA014

查询"127083FK939JX00PY"供应商